

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

ON Semiconductor®

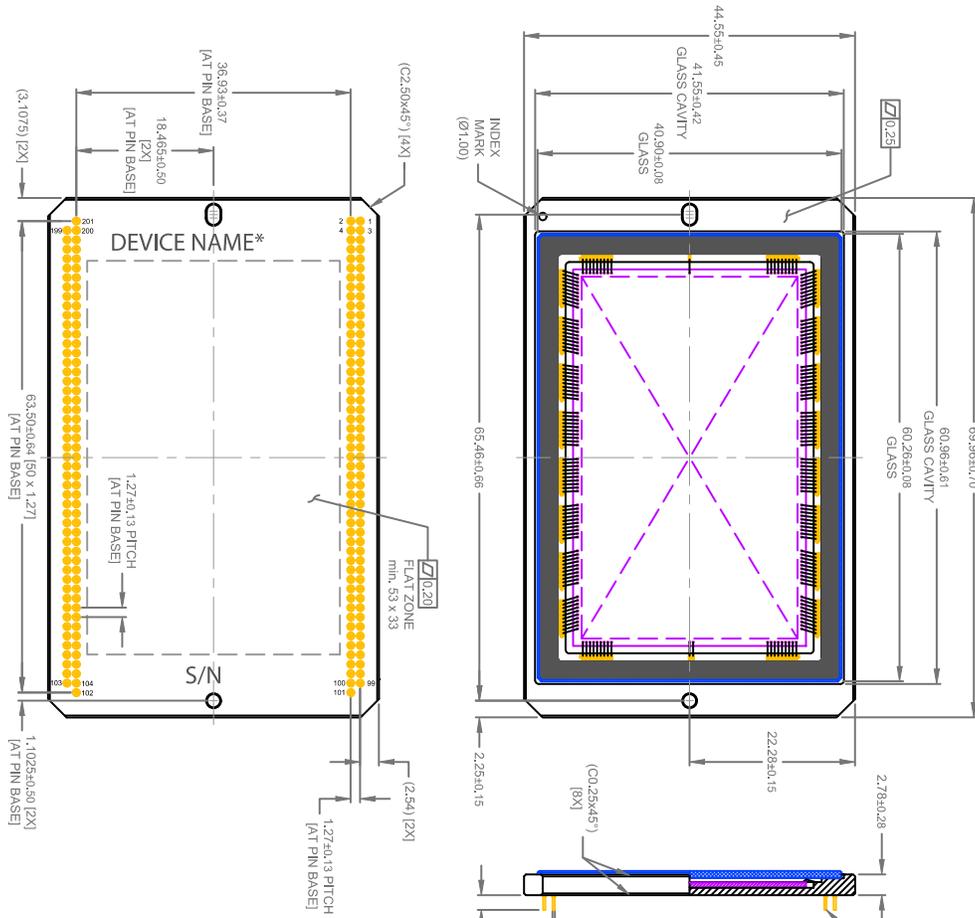


CPGA201, 69.96x44.55

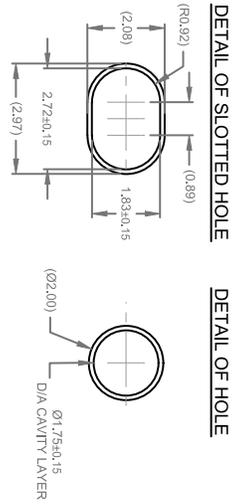
CASE 107EX

ISSUE O

DATE 05 NOV 2014



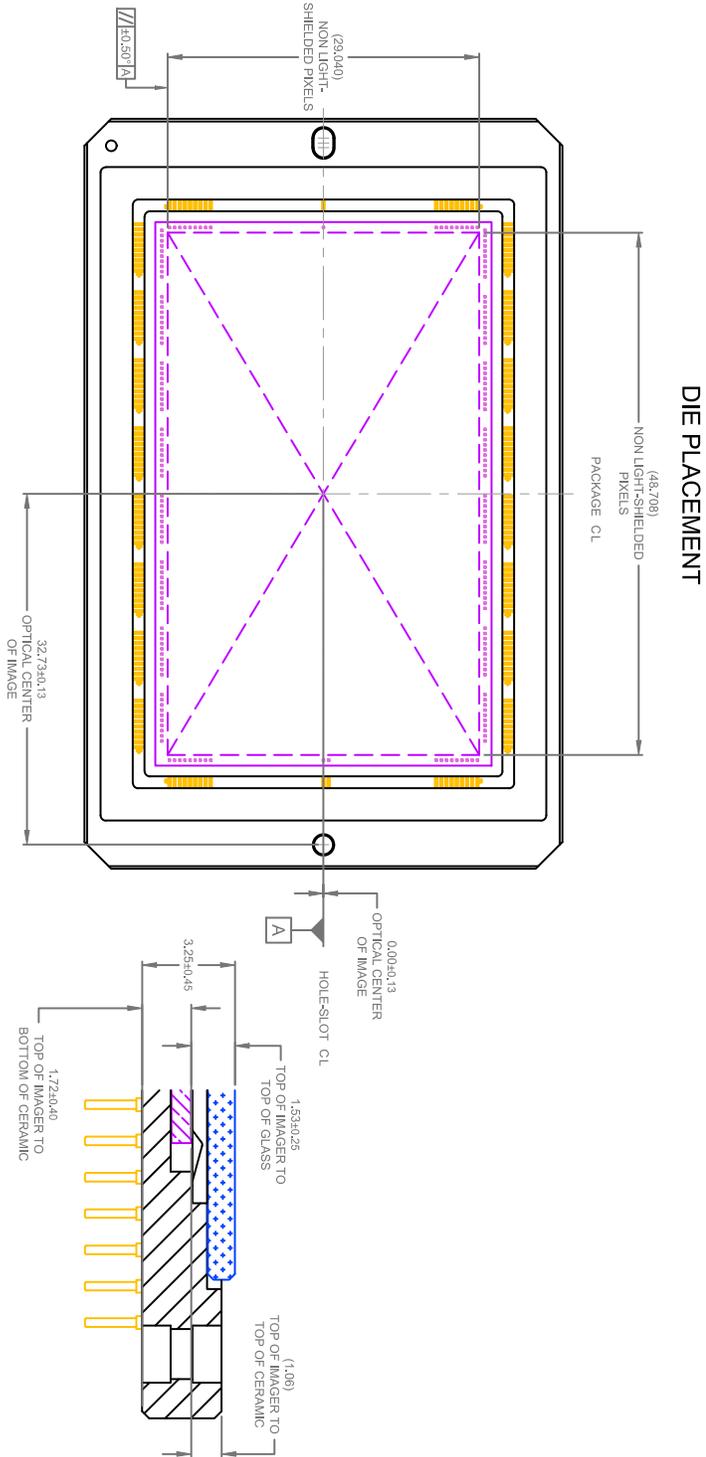
- NOTES:**
1. PIN TO PIN DISTANCES ARE MEASURED AT PIN BASE
 2. PINS ARE NOT CENTERED ABOUT THE VERTICAL AXIS



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DESCRIPTION:	CPGA201, 69.96x44.55	PAGE 1 OF 3

CPGA201, 69.96x44.55
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- NOTES:**
1. THE OPTICAL CENTER OF THE IMAGE IS AT THE CENTER OF THE DIE

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